Toshiba Intelligent Power Device Silicon Monolithic Power MOS Integrated Circuit

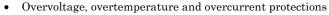
TPD1039F

Low-Side Power Switch for Motor, Solenoid and Lamp Drivers

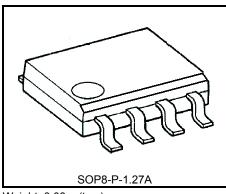
The TPD1039F is a monolithic power IC intended for low-side load switching applications. The output has a vertical MOSFET, and the input can be directly driven from CMOS or TTL logic (e.g., an MPU). The TPD1039F provides intelligent protection functions.

Features

- A structure that incorporates control circuitry and a vertical power MOSFET on a single chip.
- Can be directly driven from a microprocessor, a CMOS logic IC, etc.

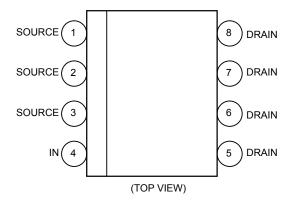


- Low ON-resistance: RDS (ON) = 0.25Ω (max) (@V_{IN} = 5 V, I_D = 1 A, T_{ch} = 25°C)
- Housed in the 8-pin SOP package and supplied in embossed carrier tape.

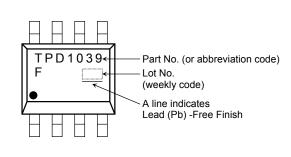


Weight: 0.08 g (typ.)

Pin Assignment (top view)

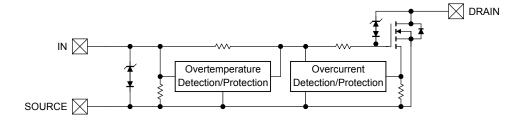


Marking



Note: This product has a MOS structure and is sensitive to electrostatic discharge.

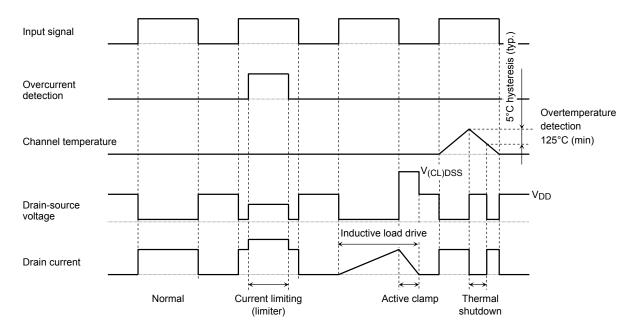
Block Diagram



Pin Description

Pin No.	Symbol	Pin Description
1, 2, 3	SOURCE	Source (ground) pins.
4	IN	Input pin. This pin is connected to a pull-down resistor internally, so that even if the input is open-circuited, the output never turns on inadvertently.
5 ,6, 7, 8	DRAIN	Drain pins. The output current is limited to 5 A (typ.) even if an excessive current flows into a device due to an in-rush current of a lamp or load short-circuit.

Timing Chart



Truth Table

V _{IN}	V_{DS}	Output State	Operating State		
L	Н	Off	Normal		
Н	L	On	Noma		
L	Н	Off	Load short-circuited		
Н	Н	Current limiting(limiter)	Load Short-circuited		
L	Н	Off	Overtemperature		
Н	Н	Off	Overtemperature		

Absolute Maximum Ratings (Ta = 25°C)

Characteristics	Symbol	Rating	Unit
Drain-source voltage	V _{DS (DC)}	45	V
Drain current	I _{D (DC)}	1.5	Α
Input voltage	V _{IN}	−0.5 to 6	V
Power dissipation (Note 2-a)	P _{D(1)}	1.1	W
Power dissipation (Note 2-b)	P _{D(2)}	0.425	W
Single pulse active clamp capability (Note 3)	Eas	20	mJ
Active clamp current	I _{AR}	1.5	Α
Repetitive active clamp capability (Note 2-a) (Note 4)	E _{AR}	0.11	mJ
Operating temperature	T _{opr}	-40 to 85	°C
Channel temperature	T _{ch}	150 (Note 5)	°C
Storage temperature	T _{stg}	−55 to 150	°C

Note 1: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

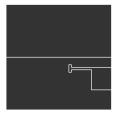
Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Thermal Characteristics

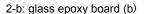
Characteristics	Symbol	Rating	Unit	
The control and independent of the control and	Par / 1	113.5 (Note 2-a)	°C /W	
Thermal resistance, channel to ambient	R _{th(ch-a)}	294.0 (Note 2-b)]	

Note 2:

2-a: glass epoxy board (a)



FR-4 25.4 × 25.4 × 0.8 (unit: mm)





FR-4 $25.4 \times 25.4 \times 0.8$ (unit: mm)

Note 3: Active clamp capability (single pulse) test condition V_{DD} = 25 V, T_{Ch} = 25°C (initial), L = 10 mH, I_{AR} = 1.5 A, R_G = 25 Ω

Note 4: Repetitive rating: Pulse width limited by maximum channel temperature

Note 5: Overtemperature protection is tripped at a channel temperature of 125°C.

Ensure that the channel temperature, Tch, does not exceed 125°C under the worst-case conditions.

Electrical Characteristics (T_{ch} = 25°C)

Characteristics	Symbol	Test Circuit	Test Condition	Min	Тур.	Max	Unit
Drain-source clamp voltage	V (CL)DSS	-	$V_{IN} = 0 \text{ V}, I_D = 1 \text{ mA}$	45	-	-	V
High-level input voltage	V _{IH}	1	$V_{DS} = 10 \text{ to } 40 \text{ V}, I_D \ge 1 \text{ A}$	3.5	-	6	V
Low-level input voltage	V _{IL}	1	$V_{DS} = 10$ to 40 V, $I_D \le 10 \mu A$	-	-	0.8	V
Drain cut-off current	I _{DSS}	-	$V_{IN} = 0 \text{ V}, V_{DS} = 40 \text{ V}$	-	-	10	μА
High-level input current	lін	-	V _{IN} = 5 V, at normal operation		-	400	μΑ
Drain-source ON-resistance	R _{DS(ON)}	-	V _{IN} = 5 V, I _D = 1 A	-	-	0.25	Ω
Protective circuit operation input Voltage range	V _{IN(opr)}	-	-	3.5	-	6	V
Overtemperature detection (Note 6)	Тот	2	V _{IN} = 5 V, V _{DD} = 12 V	125	-	-	°C
Overcurrent detection	loc	3	V _{IN} = 5 V, V _{DS} = 24 V	-	5	-	Α
Switching times	t _{on}	t _{on} 4	V _{DD} = 24 V, V _{IN} = 0 V/5 V,	-	15	-	0
Switching times	t _{off}		$R_L = 24\Omega$	-	45	-	μS
Drain-source diode forward Voltage	V _{DSF}	-	V _{IN} = 0 V, I _{DR} = 1.5 A	-	0.9	1.8	٧

Note 6: Overtemperature protection is tripped at a channel temperature of 125°C.

Ensure that the channel temperature, Tch, does not exceed 125°C under the worst-case conditions.

This feature is intended to protect the device against damage. The device reliability is not guaranteed if the

Test Circuit 1

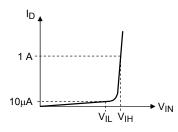
H-level input voltage, L-level input voltage measuring circuit

device persists to remain overtemperature protection mode.

Test circuit

DRAIN TPD1039F VDD = 10 to 40 V

Measured waveforms



Test Circuit 2

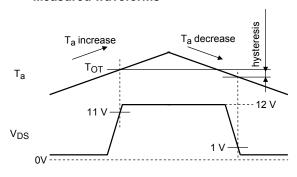
Overtemperature detection measuring circuit

Test circuit

$R_L = 1.2k\Omega$ DRAIN TPD1039F VDD = 12 V SOURCE

Measured waveforms

4



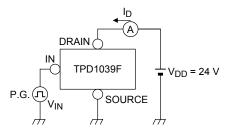
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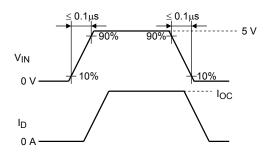
Test Circuit 3

Overcurrent detection circuit

Test circuit



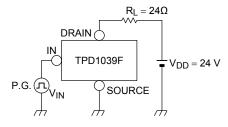
Measured waveforms



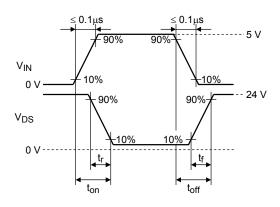
Test Circuit 4

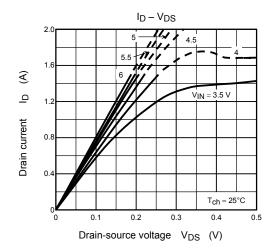
Switching time measuring circuit

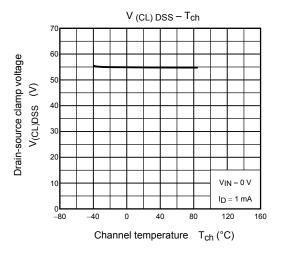
Test circuit

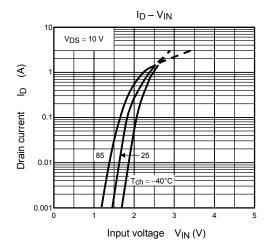


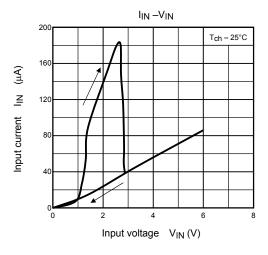
Measured waveforms

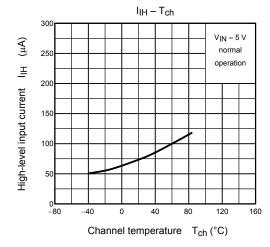


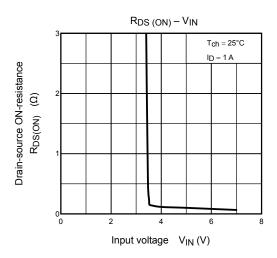


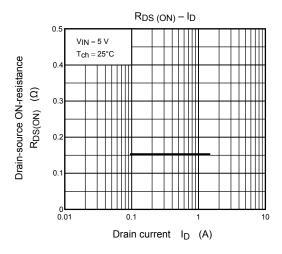


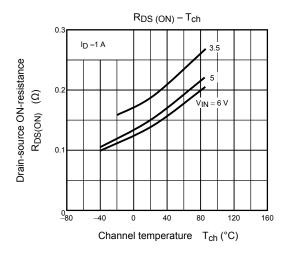


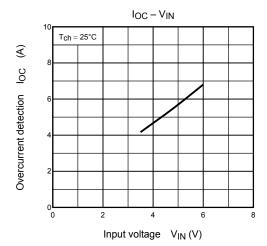


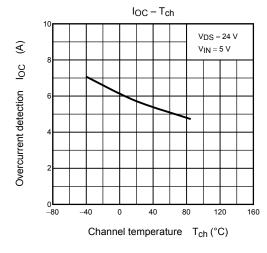


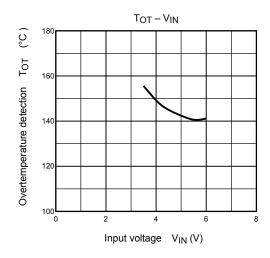


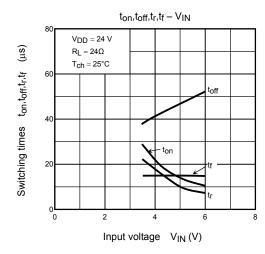


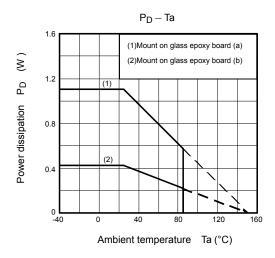


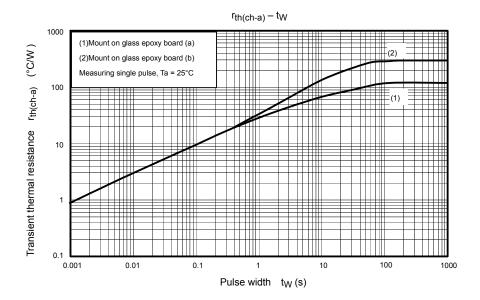




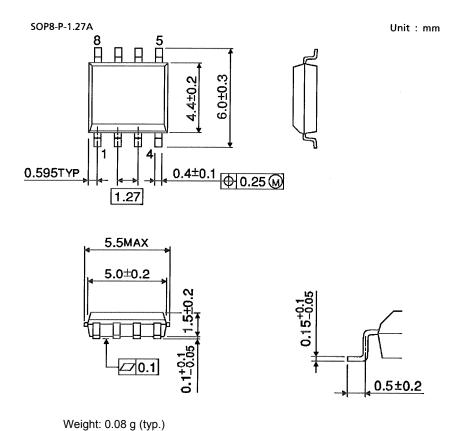








Package Dimensions



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